(Application Number)

Att rney D cket No. 36856.1154

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled HIGH-FREQUENCY SUPERPOSING MODULE FOR DRIVING LASER **DIODE** the specification of which is attached hereto unless the following box is checked: _____ as United States Application Number or PCT International was filed on ___ _____and was amended on ______ (if applicable). Application Number ____ I hereby state that I have reviewed and understand the contents of the above identified specification. including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56. I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Prior Foreign Application(s) Priority Date <u>Priority</u> Claimed 2003-039580 February 18, 2003 Japan Yes No (Number) (Country) (PCT) (Day/Month/Year \boxtimes Filed) I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below. (Application Number) (Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filling date of the prior application and the national or PCT International filling date of this application.

(Filing Date)

(Application Number)		(Filing Date)		(Status – patented, pending, abandoned)		g,
(Application Number)		(Filing Date)		(Status – patented, pending, abandoned)		
I hereby appoint the forbusiness in the Paten	ollowing attorn t and Tradema	ey(s) and/or agent(a ark Office connected	s) to prosecute th d therewith:	is application	on and to trans	act all
Joseph R. Keating, Ro Christopher A. Benne						
Address all correspondence to:		Keating & Bennett LLP 10400 Eaton Place, Suite 312 Fairfax, VA 22030 (703) 385-5200				
I hereby declare that a on information and be knowledge that willful under Section 1001 or jeopardize the validity	false statement false statement f Title 18 of the	ed to be true; and funts and the like so noted the like so noted. States Cod	irther that these s nade are punisha le and that such v	tatements v	were made with	n the
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